

08-22-2007

1 SHEET



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Our Ref.: -4593-100

To the Director of the U.S. Patent and

ed original documents or copy thereof.

1. Name of conveying party(ies):

1 Ichiro YAGI 5  
2 DeFeng LU 6  
3 XiaoGang YANG 7  
4 DeYu HE 8

Additional name/s of conveying party/ies attached? ☐

3. Nature of conveyance:

☒ Assignment ☐ Merger  
☐ Security Assignment ☐ Change of Name  
☐ Other

Execution Date: May 11, 2007

2. Name and address of receiving party(ies):

1) Name: SAE Magnetics (H.K.) Ltd.  
Street Address: SAE Technology Centre, 6 Science Park  
East Avenue, Hong Kong Science Park,  
Shatin, N.T.

City: Hong Kong

State/Country: People's Republic of China

2) Name

Street Address:

City:

State:

Zip:

Additional name/s & address/es attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

☒ This assignment is being filed together with a new application.

A. Patent Application No(s).

(1) Unknown

(2)

(3)

B. Patent No(s).

(1)

(2)

(3)

Additional numbers attached ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Joseph S. Presta

Internal Address:

Street Address: Nixon & Vanderhye P.C.

901 North Glebe Road

11th Floor

City: Arlington State: VA Zip: 22203

6. Total number of applications & patents involved: 1

7. Total fee (37 CFR 3.41)

\$ 40.00

☒ Enclosed

☐ Authorized to be charged to deposit account #14-1140

8. The Commissioner is hereby authorized to charge any deficiency in the fee(s) filed, or asserted to be filed, or which should have been filed herewith (or with any paper thereafter filed in this application by this firm) to our Account No. 14-1140.

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9. Statements and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Joseph S. Presta

Name of Person Signing

Reg. No. 35,329

Signature Reg. No. 32,318

Date

August 15, 2007

Total number of pages including original cover sheet, attachments, and document:

[3]

48.00 OP

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

# ASSIGNMENT OF PATENT APPLICATION

(Inventors) (1) YAGI ICHIRO (2) Lu, DeFeng  
(3) Yang, XiaoGang (4) He, DeYu

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(Assignee) **SAE Magnetics (H.K.) Ltd.**  
(Address) (of **SAE Technology Centre, 6 Science Park East Avenue, Hong Kong**  
**Science Park, Shatin, N.T., Hong Kong, People's Republic of China**  
(hereinafter designated as the Assignee) the undersigned's entire right, title and interest  
for the United States, its territories, dependencies and possessions, and for the country of  
(Other in the invention, and all application(s) for patent and any Letters Patent which may  
Countries) be granted therefor, known as  
(Title) **SURFACE TREATMENT METHOD FOR SOLDER JOINT**  
for which the undersigned has (have) executed on even date herewith an application for  
patent in the United States of America or, if not on even date, then has executed  
(on or has already filed in  
(U.S. appln. Serial No. filed on ).  
The undersigned acknowledges an obligation of assignment of this invention to said  
assignee at the time the invention was made.

The undersigned agree(s) to execute all papers and documents necessary in connection with the application or any interference which may be declared and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient and further to perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of NIXON & VANDERHYE P.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document. It is understood and agreed that ASSIGNEE'S attorneys Nixon & Vanderhye P.C. have represented only ASSIGNEE and will continue to represent only ASSIGNEE with respect to this invention.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned signature(s).

Date	<u>11/5/2007</u>	Signature of inventor	<u>Ichiro Tani</u>
Date	<u>5/11/07</u>	Signature of inventor	<u>Luoy Luojun</u>
Date	<u>5/11/07</u>	Signature of inventor	<u>Xiaobing Yang</u>
Date	<u>5/11/07</u>	Signature of inventor	<u>De Yu ste</u>
Date	_____	Signature of inventor	_____
Date	_____	Signature of inventor	_____
Date	_____	Signature of inventor	_____
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Date	_____	Signature of inventor	_____
Date	_____	Signature of inventor	_____
Date	_____	Signature of inventor	_____

Witnessed by: Ma, Ning  
 Witnessed by: [Signature]  
 Witnessed by: Ni, Xiaomin

Date 11/5/2007  
 Date 11/5/2007  
 Date 11/5/2007